

ELM34401AA-N-VB Datasheet P-Channel 30-V (D-S) MOSFET

| PRODUCT SUMMARY | | | | | | | |
|---------------------|------------------------------------|---------------------------------|-----------------------|--|--|--|--|
| V _{DS} (V) | $R_{DS(on)}\left(\Omega\right)$ | I _D (A) ^d | Q _g (Typ.) | | | | |
| - 30 | 0.018 at V _{GS} = - 10 V | - 9.0 | 13 nC | | | | |
| - 30 | 0.024 at V _{GS} = - 4.5 V | - 7.8 | 13110 | | | | |

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- Trench Power MOSFET
- 100 % R_g Tested

Pb-free RoHS

COMPLIANT HALOGEN FREE

APPLICATIONS

- Load Switch
- · Battery Switch



P-Channel MOSFET

| | | SO-8 | | | |
|------------------|-------|----------|---|-------------|-------------|
| S S S G | 1 2 3 | | | 8 7 6 | D D D |
| G | 4 | Top View | , | 5 | U |

| ABSOLUTE MAXIMUM RATINGS T | A = 25 °C, unless other | erwise noted | | | |
|--|-----------------------------------|------------------|-----------------------|-----|--|
| Parameter | Symbol | Limit | Unit | | |
| Drain-Source Voltage | V _{DS} | - 30 | V | | |
| Gate-Source Voltage | | V_{GS} | ± 20 | V | |
| | T _C = 25 °C | | - 9.0 | | |
| Continuous Proin Current (T. – 150 °C) | T _C = 70 °C | | - 7.2 | | |
| Continuous Drain Current (T _J = 150 °C) | T _A = 25 °C | l _D | - 7.0 ^{a, b} | | |
| | T _A = 70 °C | | - 5.6 ^{a, b} | Α | |
| Pulsed Drain Current | I _{DM} | - 30 | | | |
| Outilities Out Paris Birth Out To | | | - 3.5 | | |
| Continuous Source-Drain Diode Current | T _A = 25 °C | - I _S | - 2.1 ^{a, b} | | |
| | T _C = 25 °C | | 4.2 | | |
| Manifestore Device District | T _C = 70 °C | | 2.7 | 10/ | |
| Maximum Power Dissipation | T _A = 25 °C | P _D | 2.5 ^{a, b} | W | |
| | T _A = 70 °C | | 1.6 ^{a, b} | | |
| Operating Junction and Storage Temperature Range | T _J , T _{stg} | - 55 to 150 | °C | | |

| THERMAL RESISTANCE RATINGS | | | | | | |
|---|--------------|-------------------|---------|---------|------|--|
| Parameter | | Symbol | Typical | Maximum | Unit | |
| Maximum Junction-to-Ambient ^{a, c} | t ≤ 10 s | R _{thJA} | 40 | 50 | °C/W | |
| Maximum Junction-to-Foot | Steady State | R _{thJF} | 24 | 30 | C/VV | |

Notes:

- a. Surface mounted on 1" x 1" FR4 board.
- b. t = 10 s.
- c. Maximum under Steady State conditions is 95 °C/W.
- d. Based on $T_C = 25$ °C.



| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit |
|---|-------------------------|--|-------|--------|-------|--------|
| Static | | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0 \text{ V, } I_{D} = -250 \mu\text{A}$ | - 30 | | | V |
| V _{DS} Temperature Coefficient | | | | - 31 | | m\//°C |
| V _{GS(th)} Temperature Coefficient | $\Delta V_{GS(th)}/T_J$ | - I _D = - 250 μA | | 4.5 | | mV/°C |
| Gate-Source Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_{D} = -250 \mu A$ | - 1.0 | | - 2.5 | V |
| Gate-Source Leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$ | | | ± 100 | nA |
| Zero Gate Voltage Drain Current | lana | V _{DS} = - 30 V, V _{GS} = 0 V | - 1 | | - 1 | μА |
| Zero Gate voltage Drain Current | I _{DSS} | $V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 \text{ °C}$ | | | - 5 | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \le -5 \text{ V}, V_{GS} = -10 \text{ V}$ | - 20 | | | Α |
| David Course Co Otata Basista and | _ | V _{GS} = - 10 V, I _D = - 7.0 A | 0.018 | | | |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | V _{GS} = - 4.5 V, I _D = - 5.6 A | | 0.024 | | Ω |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = - 15 V, I _D = - 7.0 A | | 18 | | S |
| Dynamic ^b | | | | | | • |
| Input Capacitance | C _{iss} | | | 1455 | | |
| Output Capacitance | C _{oss} | $V_{DS} = -15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ | | 180 | | pF |
| Reverse Transfer Capacitance | C _{rss} | | | 145 | | |
| Tatal Oata Obanna | Q _g | $V_{DS} = -15 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -7.0 \text{ A}$ | 25 | 38 | | |
| Total Gate Charge | | | | 13 | 20 | nC |
| Gate-Source Charge | Q_{gs} | $V_{DS} = -15 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -7.0 \text{ A}$ | | 3.5 | | |
| Gate-Drain Charge | Q _{gd} | | | 5.5 | | |
| Gate Resistance | R _g | f = 1 MHz | 0.4 | 2.0 | 4.0 | Ω |
| Turn-On Delay Time | t _{d(on)} | | | 10 | 20 | |
| Rise Time | t _r | $V_{DD} = -15 \text{ V}, R_{L} = 2.7 \Omega$ | | 13 | 20 | 1 |
| Turn-Off DelayTime | t _{d(off)} | $I_D \cong$ - 5.6 A, V_{GEN} = - 10 V, R_g = 1 Ω | | 23 | 35 |] |
| Fall Time | t _f |] | | 9 | 18 | |
| Turn-On Delay Time | t _{d(on)} | | | 38 | 57 | ns |
| Rise Time | t _r | $V_{DD} = -15 \text{ V}, R_{L} = 2.7 \Omega$ | | 89 | 134 | |
| Turn-Off DelayTime | t _{d(off)} | $I_D \cong$ - 5.6 A, V_{GEN} = - 4.5 V, R_g = 1 Ω | | 22 | 33 | 1 |
| Fall Time | t _f |] | | 11 | 17 |] |
| Drain-Source Body Diode Characteris | tics | | | | | |
| Continous Source-Drain Diode Current | I _S | T _C = 25 °C | | | - 6.5 | Λ. |
| Pulse Diode Forward Current | I _{SM} | | | | - 30 | A |
| Body Diode Voltage | V _{SD} | I _S = - 5.6 A, V _{GS} = 0 V | | - 0.71 | - 1.2 | V |
| Body Diode Reverse Recovery Time | t _{rr} | | | 22 | 33 | ns |
| Body Diode Reverse Recovery Charge | Q _{rr} | 1 - F.C.A. dl/dt - 100 A/v.o. T | | 17 | 26 | nC |
| Reverse Recovery Fall Time | t _a | $I_F = -5.6 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$ | | 13 | | ns |
| Reverse Recovery Rise Time | t _b | 1 | | 9 | | |

Notes:

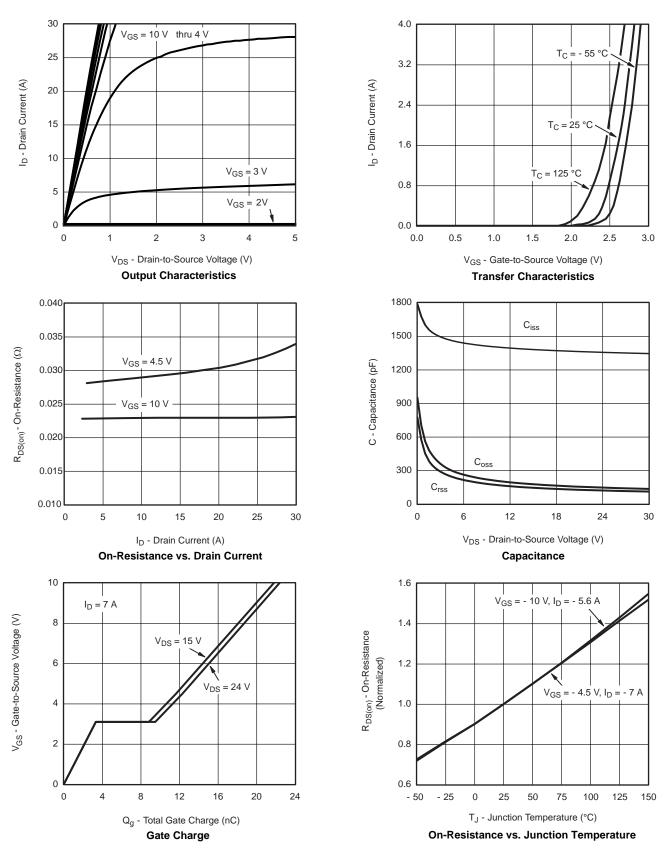
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

服务热线:400-655-8788 2

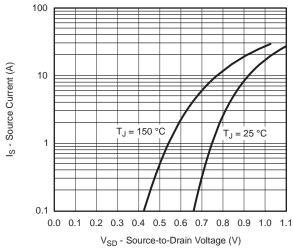
a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$

b. Guaranteed by design, not subject to production testing.

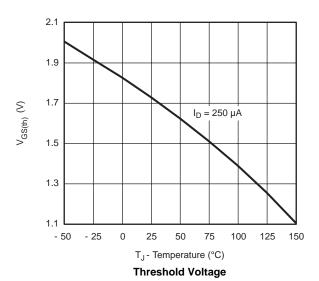








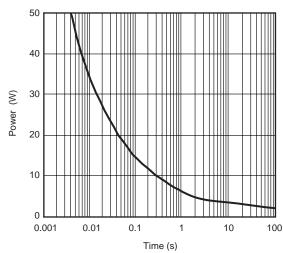
Source-Drain Diode Forward Voltage



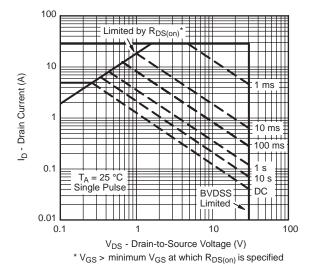
 $C_{\text{O}} = 7 \text{ A}$ C_{O

V_{GS} - Gate-to-Source Voltage (V)

On-Resistance vs. Gate-to-Source Voltage



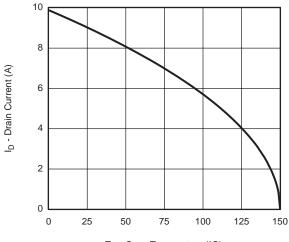
Single Pulse Power, Junction-to-Ambient



Safe Operating Area

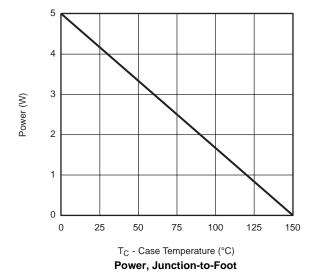
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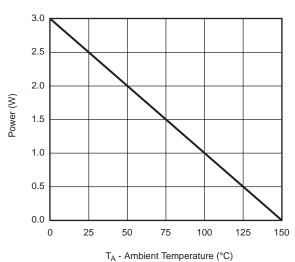




T_C - Case Temperature (°C)



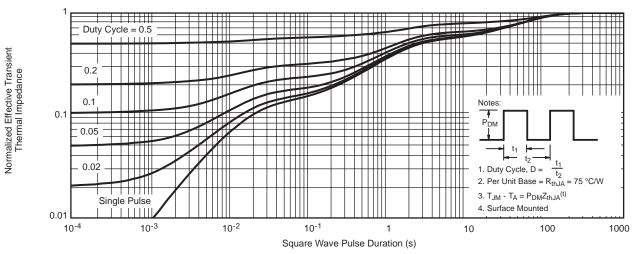




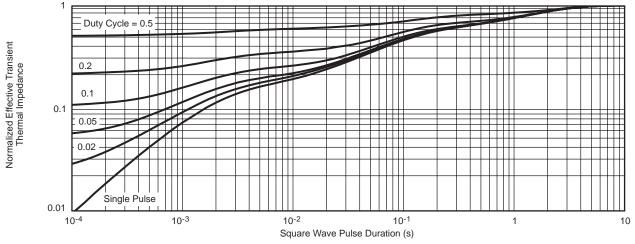
Power Derating, Junction-to-Ambient

^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





Normalized Thermal Transient Impedance, Junction-to-Ambient

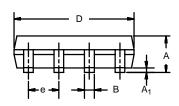


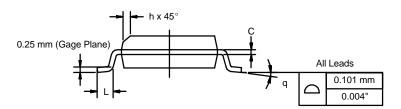
Normalized Thermal Transient Impedance, Junction-to-Foot



SOIC (NARROW): 8-LEADJEDEC Part Number: MS-012







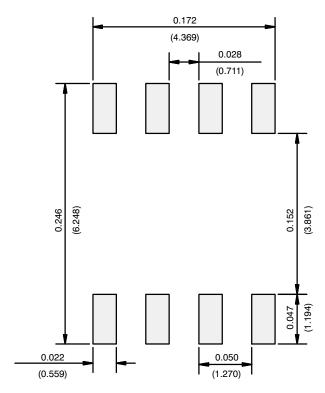
| | MILLIMETERS | | INC | HES | | |
|------------------------------|-------------|------|-----------|-------|--|--|
| DIM | Min | Max | Min | Max | | |
| Α | 1.35 | 1.75 | 0.053 | 0.069 | | |
| A ₁ | 0.10 | 0.20 | 0.004 | 0.008 | | |
| В | 0.35 | 0.51 | 0.014 | 0.020 | | |
| С | 0.19 | 0.25 | 0.0075 | 0.010 | | |
| D | 4.80 | 5.00 | 0.189 | 0.196 | | |
| E | 3.80 | 4.00 | 0.150 | 0.157 | | |
| е | 1.27 | BSC | 0.050 BSC | | | |
| Н | 5.80 | 6.20 | 0.228 | 0.244 | | |
| h | 0.25 | 0.50 | 0.010 | 0.020 | | |
| L | 0.50 | 0.93 | 0.020 | 0.037 | | |
| q | 0° | 8° | 0° | 8° | | |
| S | 0.44 | 0.64 | 0.018 | 0.026 | | |
| FCN: C-06527-Rev I 11-Sen-06 | | | | | | |

ECN: C-06527-Rev. I, 11-Sep-06

DWG: 5498



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)



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